



60V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	Rds(on) Max	I _D Max T _A = +25°C
60V	6.5mΩ @ V _{GS} = 10V	14.6A
	10mΩ @ V _{GS} = 4.5V	11.8A

Features and Benefits

- 100% Unclamped Inductive Switching (UIS) Test in Production —
 Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low Rds(ON) Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

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https://www.diodes.com/quality/product-definitions/

Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) and maintain superior switching performance, which makes it ideal for high-efficiency power management applications.

- High-Frequency Switching
- Synchronous Rectification
- DC-DC Converters

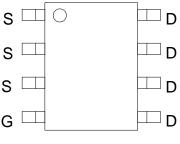
Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (2)
- Weight: 0.076 grams (Approximate)

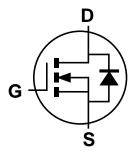
SO-8



Top View



Pin-Out Top View



Equivalent Circuit

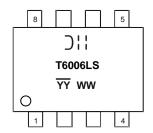
Ordering Information (Note 4)

Part Number	Case	Packaging
DMT6006LSS-13	SO-8	2500/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



);; = Manufacturer's Marking
T6006LS = Product Type Marking Code
YYWW = Date Code Marking
YY = Year (ex: 19 = 2019)
WW = Week (01 to 53)

DMT6006LSS
Document number: DS42026 Rev. 2 - 2

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		VDSS	60	V
Gate-Source Voltage		Vgss	±20	V
Continuous Drain Current (Note 5) V _{GS} = 10V	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	lD	11.9 9.5	А
Continuous Drain Current (Note 6) $V_{GS} = 10V$ $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$		ID	14.6 11.7	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	110	Α	
Maximum Continuous Body Diode Forward Current (Note 6)	Is	10	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle =	Ism	110	Α	
Avalanche Current, L = 0.1mH		IAS	28.5	Α
Avalanche Energy, L = 0.1mH	Eas	40.7	mJ	

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	1.38	W
Thermal Resistance, Junction to Ambient (Note 5)	Rөja	90.3	°C/W
Total Power Dissipation (Note 6)	PD	2.08	W
Thermal Resistance, Junction to Ambient (Note 6)	Reja	60.1	°C/W
Thermal Resistance, Junction to Case (Note 6)	Rejc	6.5	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

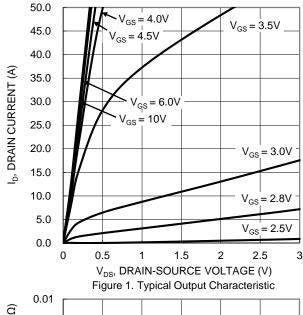
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V _{DS} = 48V, V _{GS} = 0V
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	Vgs(th)	1.3	1.74	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Static Drain-Source On-Resistance	D	_	5.0	6.5	0	$V_{GS} = 10V, I_D = 20A$
Static Drain-Source On-Resistance	RDS(ON)	_	6.7	10	mΩ	Vgs = 4.5V, ID = 10A
Diode Forward Voltage	VsD	_	0.8	1.2	V	Vgs = 0V, Is = 20A
DYNAMIC CHARACTERISTICS (Note 8)		•		•	•	
Input Capacitance	Ciss	_	2162	_		V _{DS} = 30V, V _{GS} = 0V, f = 1MHz
Output Capacitance	Coss	_	761	_	pF	
Reverse Transfer Capacitance	Crss	_	58	_		
Gate Resistance	Rg	_	0.7	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	18.1	_		V _{DS} = 30V, I _D = 20A
Total Gate Charge (Vgs = 10V)	Qg	_	34.9	_		
Gate-Source Charge	Qgs	_	6.1	_	nC	
Gate-Drain Charge	Qgd	_	7.3	_		
Turn-On Delay Time	t _{D(ON)}	_	6.0	_		$V_{GS} = 10V, V_{DD} = 30V,$ $R_{G} = 3\Omega, I_{D} = 20A$
Turn-On Rise Time	t _R	_	5.4	_		
Turn-Off Delay Time	tD(OFF)	_	20.4	_	ns	
Turn-Off Fall Time	t _F	_	7.8	_		
Reverse Recovery Time	trr	_	35.8	_	ns	100 11/11 1000/
Reverse Recovery Charge	Qrr	_	40.2	_	nC	I _F = 10A, di/dt = 100A/μs

Notes:

- 5. Device mounted on FR-4 PCB, with minimum recommended pad layout, single sided.
- 6. Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.





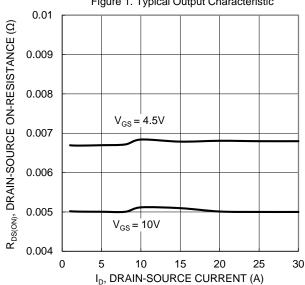
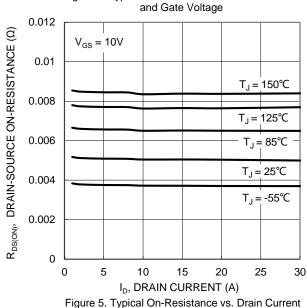


Figure 3. Typical On-Resistance vs. Drain Current



and Junction Temperature

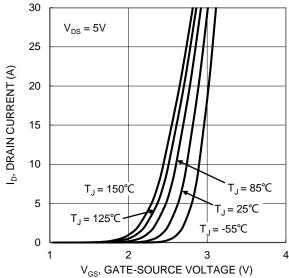
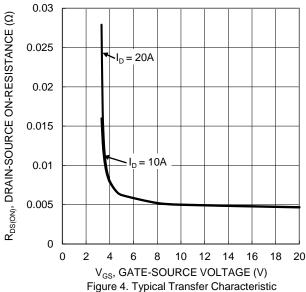


Figure 2. Typical Transfer Characteristic



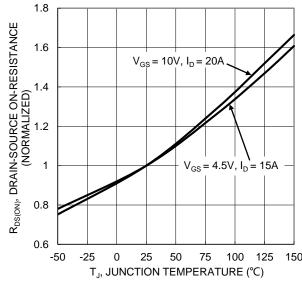


Figure 6. On-Resistance Variation with Junction Temperature



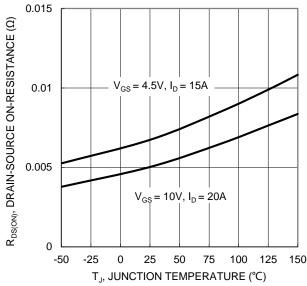


Figure 7. On-Resistance Variation with Junction Temperature

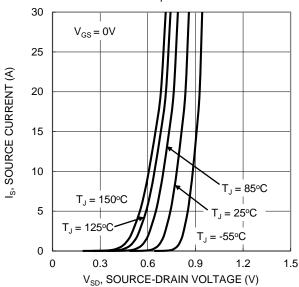
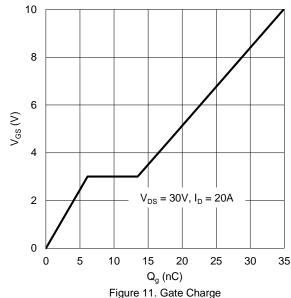
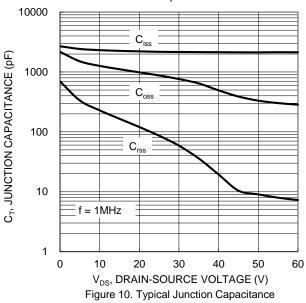


Figure 9. Diode Forward Voltage vs. Current



3 $V_{GS(TH)},$ GATE THRESHOLD VOLTAGE (V) 2.5 $I_D = 1mA$ 2 1.5 $I_{D} = 250 \mu A$ 0.5 0 -25 0 25 50 75 100 125 -50 150 T_J, JUNCTION TEMPERATURE (°C)

Figure 8. Gate Threshold Variation vs. Junction Temperature



1000 R_{DS(ON)} Limited = 100µs 100 DRAIN CURRENT (A) 10 $P_W = 10 \text{ms}$ 🖆 100ms 0.1 $T_{J(Max)} = 150^{\circ}C$ $P_W = 1s$ T_C = 25℃ Single Pulse 0.01 DUT on 1*MRP Board $V_{GS} = 10V$ 0.001 0.01 10 100 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



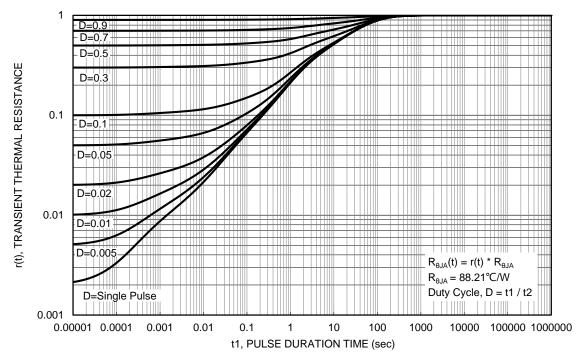


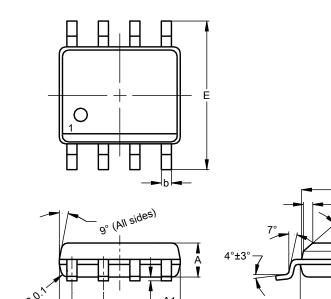
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8



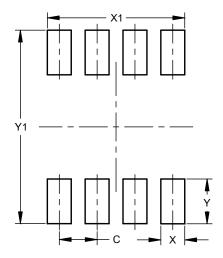
SO-8				
Dim	Min	Max	Тур	
Α	1.40	1.50	1.45	
A1	0.10	0.20	0.15	
b	0.30	0.50	0.40	
С	0.15	0.25	0.20	
D	4.85	4.95	4.90	
Е	5.90	6.10	6.00	
E1	3.80	3.90	3.85	
E0	3.85	3.95	3.90	
е			1.27	
h	-		0.35	
L	0.62	0.82	0.72	
ø	0.60	0.70	0.65	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8

Gauge Plane Seating Plane



Dimensions	Value (in mm)
C	1.27
Х	0.802
X1	4.612
Y	1.505
V1	6.50



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